DATA SHEET

Solid State Relay OCMOS FET

PS7141E-1A, PS7141EL-1A

6-PIN DIP, 400V BREAK DOWN VOLTAGE

NORMALLY OPEN TYPE

1-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

NEC

The PS7141E-1A and PS7141EL-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7141EL-1A has a surface mount type lead.

FEATURES

- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- Ordering number of taping product: PS7141EL-1A-E3, E4: 1 000 pcs/reel
- Pb-Free product
- <R> Safety standards

<R>

- UL approved: File No. E72422
- BSI approved: No. 8806/8807
- SEMKO approved: No. 313447
- DEMKO approved: No. 312887
- NEMKO approved: No. P4202453
- FIMKO approved: No. FI 20732

APPLICATIONS

- · Exchange equipment
- Measurement equipment
- FA/OA equipment

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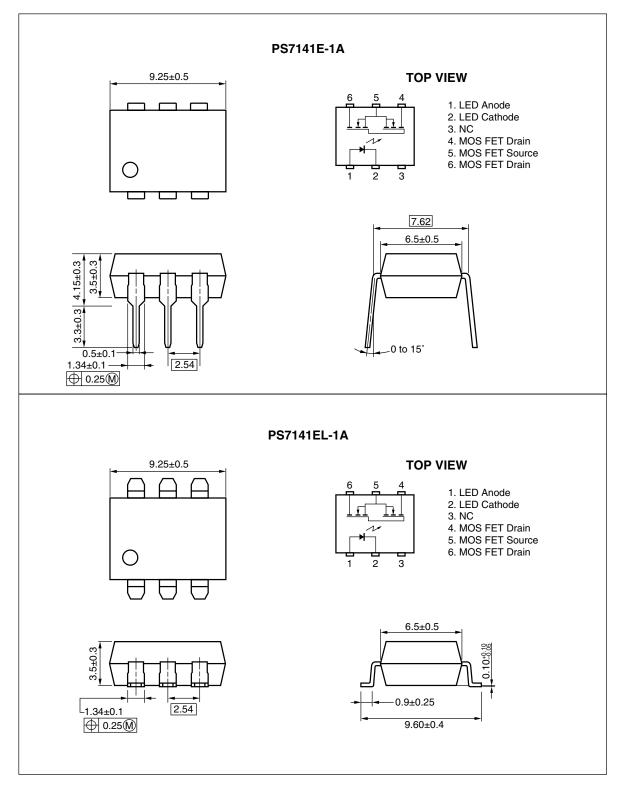
Document No. PN10439EJ02V0DS (2nd edition) Date Published July 2006 NS CP(K) Printed in Japan

The mark <R> shows major revised points.

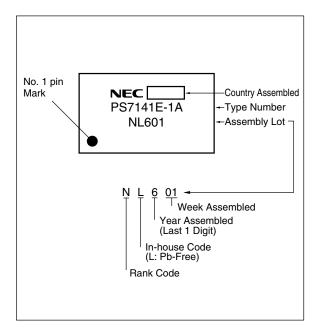
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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (in millimeters)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{•1} |
|----------------|------------------|---------------------------------|------------------------------|-----------------------------|--|
| PS7141E-1A | PS7141E-1A-A | Pb-Free | Magazine case 50 pcs | Standard products | PS7141E-1A |
| PS7141EL-1A | PS7141EL-1A-A | | | (UL, BSI, SEMKO, | |
| PS7141EL-1A-E3 | PS7141EL-1A-E3-A | | Embossed Tape 1 000 pcs/reel | DEMKO, NEMKO, | |
| PS7141EL-1A-E4 | PS7141EL-1A-E4-A | | | FIMKO approved) | |

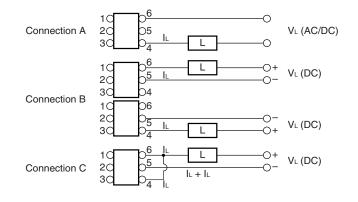
*1 For the application of the Safety Standard, following part number should be used.

| ABSOLUTE MAXIMUM RATINGS | (T _A = 25°C, unless otherwise specified) |
|--------------------------|---|
|--------------------------|---|

| Parameter | | Symbol | Ratings | Unit | |
|-------------------------------|--|--------------|-------------|---------|----|
| Diode | Forward Current (DC) | | lF | 50 | mA |
| | Reverse Voltage | | VR | 5.0 | V |
| | Power Dissipation | | PD | 50 | mW |
| | Peak Forward Curre | ent" | IFP | 1 | А |
| MOS FET | Break Down Voltage | | VL | 400 | V |
| | Continuous | Connection A | L | 120 | mA |
| | Load Current ^{*2} | Connection B | | 150 | |
| | | Connection C | | 250 | |
| | Pulse Load Current ^{*3} (AC/DC Connection) | | Ilp | 240 | mA |
| | Power Dissipation | | PD | 560 | mW |
| Isolation Voltage 4 | | BV | 1 500 | Vr.m.s. | |
| Total Power Dissipation | | Ρτ | 610 | mW | |
| Operating Ambient Temperature | | TA | -40 to +85 | °C | |
| Storage Temperature | | Tstg | -40 to +100 | °C | |

*1 PW = 100 μs, Duty Cycle = 1%

*2 Conditions: IF \geq 5 mA. The following types of load connections are available.



*3 PW = 100 ms, 1 shot

*4 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-3 shorted together, 4-6 shorted together.

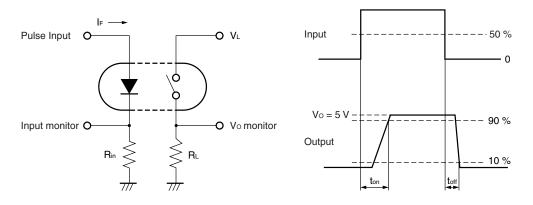
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|-----------------------|--------|------|------|------|------|
| LED Operating Current | lf | 5 | 10 | 20 | mA |
| LED Off Voltage | VF | 0 | | 0.5 | V |

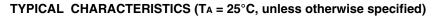
ELECTRICAL CHARACTERISTICS (TA = 25°C)

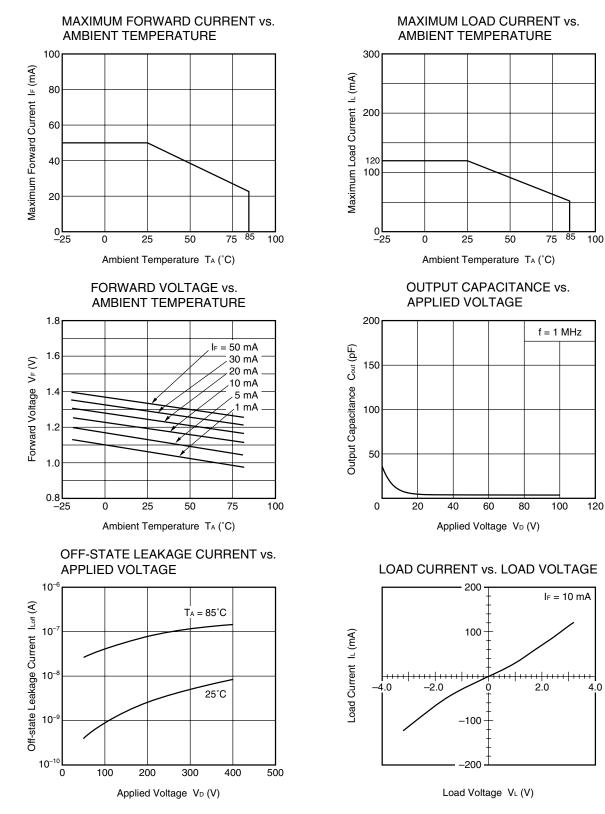
| | Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|---------|--------------------------------|-------------|---|-----------------|------|------|------|
| Diode | Forward Voltage | VF | IF = 10 mA | | 1.2 | 1.4 | V |
| | Reverse Current | IR | $V_R = 5 V$ | | | 5.0 | μA |
| MOS FET | Off-state Leakage Current | ILoff | V _D = 400 V | | 0.01 | 1.0 | μA |
| | Output Capacitance | Cout | $V_D = 0 V, f = 1 MHz$ | | 36 | | pF |
| Coupled | LED On-state Current | IFon | l∟ = 120 mA | | | 5.0 | mA |
| | On-state Resistance | Ron1 | I⊧ = 10 mA, I∟ = 10 mA | | 36 | 50 | Ω |
| | | Ron2 | I_{F} = 10 mA, I_{L} = 120 mA, $t \leq$ 10 ms | | 25 | 35 | |
| | Turn-on Time ^{*1, 2} | ton | $I_{\text{F}} = 10 \text{ mA}, \text{ V}_{\text{O}} = 5 \text{ V}, \text{ R}_{\text{L}} = 1.5 \text{ k}\Omega,$ | | 0.5 | 1.0 | ms |
| | Turn-off Time ^{*1, 2} | toff | PW ≥ 10 ms | | 0.07 | 0.2 | |
| | Isolation Resistance | R ⊦o | VI-O = 1.0 kVDC | 10 [°] | | | Ω |
| | Isolation Capacitance | CI-O | V = 0 V, f = 1 MHz | | 1.1 | | pF |

*1 Test Circuit for Switching Time



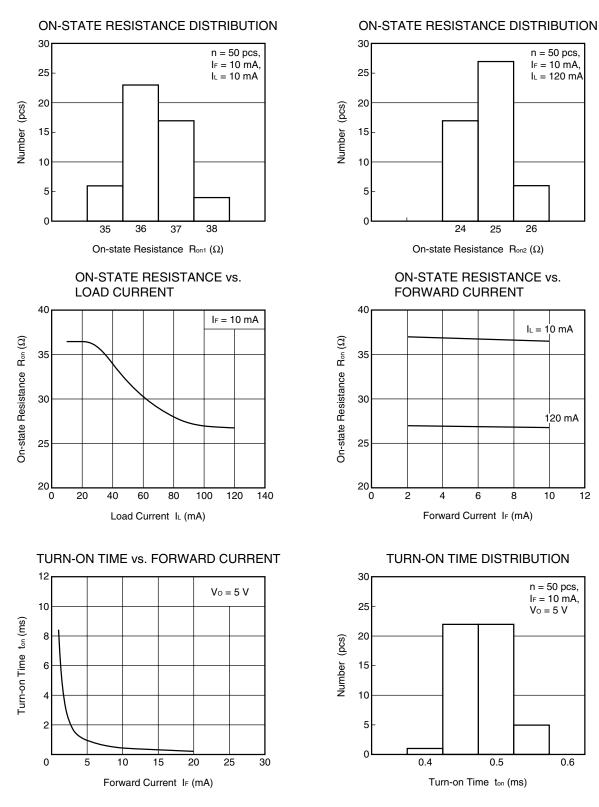
*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
 Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.





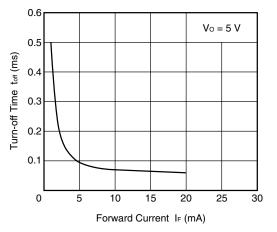
Remark The graphs indicate nominal characteristics.

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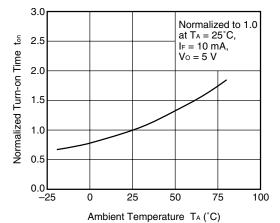


Remark The graphs indicate nominal characteristics.

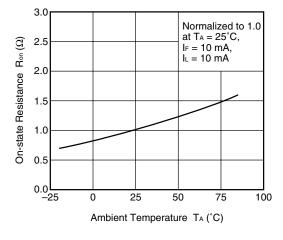
TURN-OFF TIME vs. FORWARD CURRENT



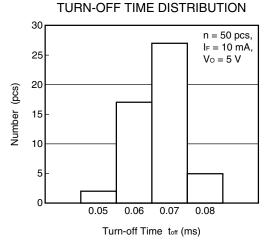




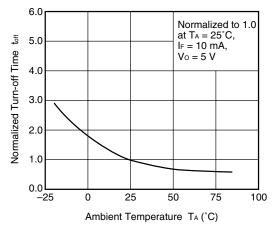




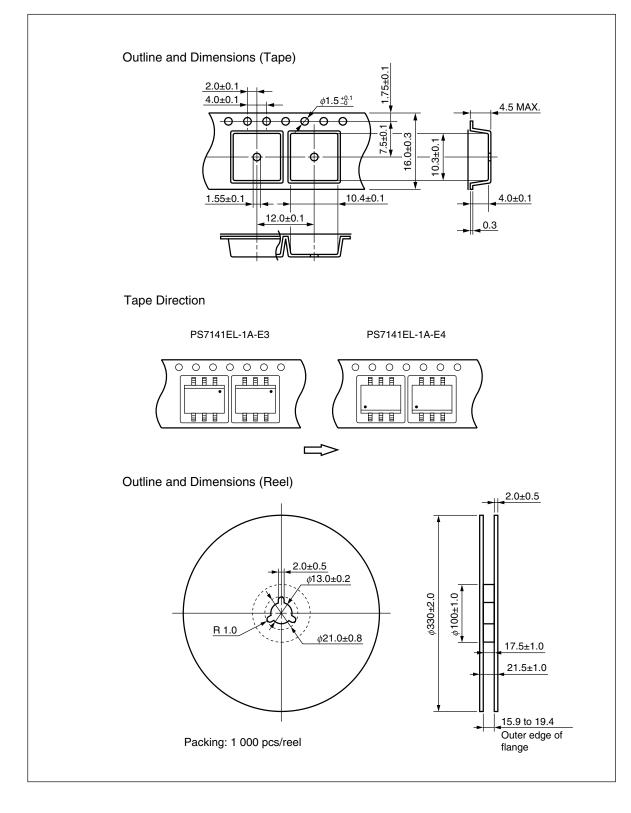
Remark The graphs indicate nominal characteristics.



NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



TAPING SPECIFICATIONS (in millimeters)



RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

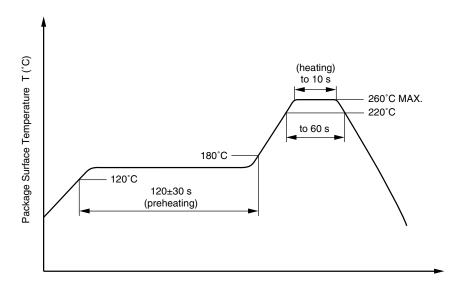
- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

260°C or below (package surface temperature)

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

| Temperature | 260°C or below (molten solder temperature) |
|---|--|
| • Time | 10 seconds or less |
| Preheating conditions | 120°C or below (package surface temperature) |
| Number of times | One |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine |
| | content of 0.2 Wt% is recommended.) |

<R> (3) Soldering by soldering iron

| Peak temperature (lead part temperature) | 350°C or below |
|--|---|
| Time (each pins) | 3 seconds or less |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a |
| | maximum chlorine content of 0.2 Wt% is recommended.) |

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

| Caution GaAs Products | This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. |
|-----------------------|---|
| | • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. |
| | Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. |
| | 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. |
| | • Do not burn, destroy, cut, crush, or chemically dissolve the product. |
| | Do not lick the product or in any way allow it to enter the mouth. |

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